

CONTROL DEVICES - BEAMLEAD PIN DIODES

RoHS Compliant





DESCRIPTION

Semiconductor mesa beam lead PIN diodes are designed for very low inductance, low resistance and moderately low capacitance with ultra fast switching characteristics. The structural details include thermal oxide junction passivation thus providing reliable operation with stable junction parameters along with ceramic glass, which provides mechanical strength to the diode. These devices are designed with a narrow base width, a high quality intrinsic 'l' layer that provides low loss, high isolation and ultra high speed switching characteristics.

This series of diodes meets RoHS requirements per EU Directive 2002/95/EC. The standard terminal finish is gold unless otherwise specified. Consult the factory if you have special requirements.

APPLICATIONS

These high speed beam lead PIN diodes are designed for stripline and microstrip circuits and are primarily used in shunt/series and conventional series multithrow configurations as switching, attenuating and phase shifting elements with frequencies extending up to Ku band.

ABSOLUTE MAXIMUM RATINGS AT 25° C

(UNLESS OTHERWISE SPECIFIED)									
Rating	Symbol	Value	Unit						
Maximum Leakage Current @80% of minimum Rated V _B	I _R	0.5	uA						
Operating Temperature	T _{OP}	-65 to +150	°C						
Storage Temperature	T _{STG}	-65 to +150	°C						

For the most current data, consult MICROSEMI's website: www.MICROSEMI.com Specifications are subject to change, consult factory for the latest information.

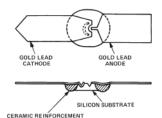
These devices are ESD sensitive and must be handled use using ESD precautions.

KEY FEATURES

- Wide Bandwidth / High Switching Speed
- 5 Gram Typical Pull Strength
- Very Low R_S/C_J (Loss/Isolation)
 Products with Low Inductance
- High Quality, High Resistivity
 Epitaxy
- Stable Low Leakage Passivation with Rugged Glass Body
- RoHS Compliant ¹

APPLICATIONS/BENEFITS

- High Speed Switching
- Broadband Performance
- Suitable for Applications through 26 Ghz



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¹These devices are supplied with Gold plated terminations. Consult factory for details



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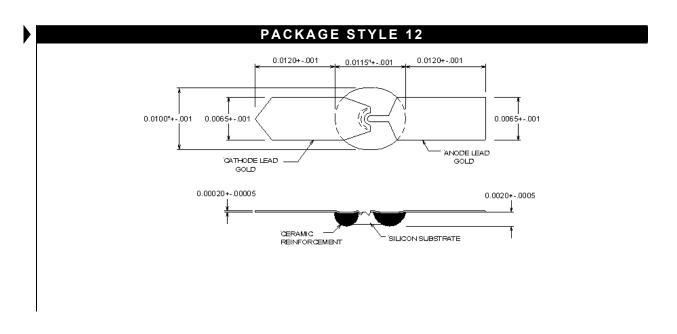




ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)										
DC Characteristics					RF Characteristics					
Model Number	V _b (V) I _R =10μΑ (Min)	C _⊤ (pF) @10∨ (Max)	R _s (Ω) I _F =10mA F=2.2GHz (Max)	$R_s(\Omega)$ $I_F=50$ mA $F=2.2$ GHz (Max)	T _L (nS) (Typ)	lsol (db)¹ ∨ _r =10∨ (Typ)	I _L (db) ¹ I _F =10mA (Typ)	I _L (db) ¹ I _F =50mA (Typ)		
GC4902 - 12	100	0.025		3.0	80	29.0		0.26		
GC4903 - 12	100	0.030		2.5	80	27.8		0.22		
GC4941 – 12	50	0.060	1.5		50	22.0	0.13			
GC4942 – 12	50	0.040	2.0		45	25.0	0.17			
GC4943 – 12	50	0.030	3.0		40	27.5	0.26			
GC4944 – 12	50	0.025	3.5		35	29.0	0.30			
GC4945 – 12	50	0.022	5.5		40	30.5	0.46			
GC4946 – 12	50	0.020	6.5		40	31.0	0.55			

Notes

1) Insertion loss and Isolation are test at F = 2.2 GHz using transmission loss techniques.



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